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MOSFET – N-Channel, POWERTRENCH[®] GreenBridge[™] Series of High-Efficiency Bridge Rectifiers

60 V, 8 A, 17.5 m Ω

FDMQ86530L

General Description

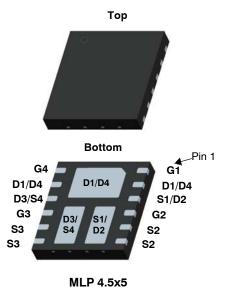
This Quad MOSFET solution provides ten-fold improvement in power dissipation over diode bridge.

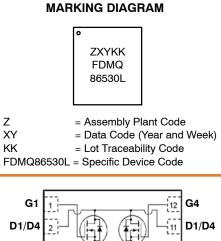
Features

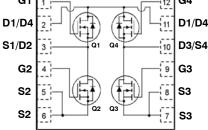
- Max $R_{DS(on)} = 17.5 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 8 \text{ A}$
- Max $R_{DS(on)} = 23 \text{ m}\Omega$ at $V_{GS} = 6 \text{ V}$, $I_D = 7 \text{ A}$
- Max $R_{DS(on)} = 25 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 6.5 \text{ A}$
- Substantial Efficiency Benefit in PD Solutions
- This Device is Pb-Free, Halide Free, and RoHS Compliant

Applications

- Active Bridge
- Diode Bridge Replacement in 24 V & 48 V AC Systems







ORDERING INFORMATION

Device	Package	Shipping [†]
FDMQ86530L	WDFN-12 (Pb-Free, Halide Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, <u>BRD8011/D</u>.

DATA SHEET www.onsemi.com

MOSFET MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter			Ratings	Unit
V _{DS}	Drain to Source Voltage			60	V
V _{GS}	Gate to Source Voltage			±20	V
I _D	Drain Current	Continuous	$T_{C} = 25^{\circ}C$	8	Α
		Continuous (Note 1a)	T _A = 25°C	8	
		Pulsed		50	
PD	Power Dissipation	•	$T_{C} = 25^{\circ}C$	22	W
	Power Dissipation (Note 1a)		T _A = 25°C	1.9	1
T _J , T _{STG}	Operating and Storage Junction	Temperature Range		-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
RθJA	Thermal Resistance, Junction to Ambient (Note 1a)	65	°C/W
RθJA	Thermal Resistance, Junction to Ambient (Note 1b)	135	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V$	60	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25°C	-	27	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS}=\pm 20$ V, $V_{DS}=~0$ V	-	-	±100	nA

ON CHARACTERISTICS

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	1	1.8	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25°C	-	-6	-	mV/°C
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 8 A	-	12	17.5	mΩ
		$V_{GS} = 6 V, I_D = 7 A$	-	15	23	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$	_	20	25	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C}$	_	18	26	
g fs	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	_	28	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 30 V, V_{GS} = 0 V, f = 1 MHz	-	1725	2295	pF
C _{oss}	Output Capacitance		-	299	400	pF
C _{rss}	Reverse Transfer Capacitance		-	10	15	pF

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 8 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	8.8	18	ns
t _r	Rise Time	$R_{GEN} = 6 \Omega$	-	3.8	10	
t _{d(off)}	Turn-Off Delay Time		-	22	35	
t _f	Fall Time		-	2.8	10	

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (continued)

Qg	Total Gate Charge	V_{GS} = 0 V to 10 V, V_{DD} = 30 V, I_{D} = 8 A	-	23	33	nC
Qg	Total Gate Charge	V_{GS} = 0 V to 4.5 V, V_{DD} = 30 V, I_{D} = 8 A	-	11	16	
Q _{gs}	Gate to Charge	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	5.1	-	
Q _{gd}	Gate to Drain "Miller" Charge		-	2.3	-	

DRAIN-SOURCE DIODE CHARACTERISTICS

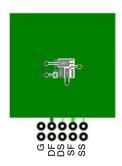
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

V _{SD}	Source to Drain Diode Forward	V _{GS} = 0 V, I _S = 8 A (Note 2)	-	0.8	1.3	V
	Voltage	V _{GS} = 0 V, I _S = 1.6 A (Note 2)	-	0.7	1.2	
t _{rr}	Reverse Recovery Time	I _F = 8 A, di/dt = 100 A/μs	-	27	43	ns
Q _{rr}	Reverse Recovery Charge		-	12	22	nC

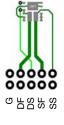
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



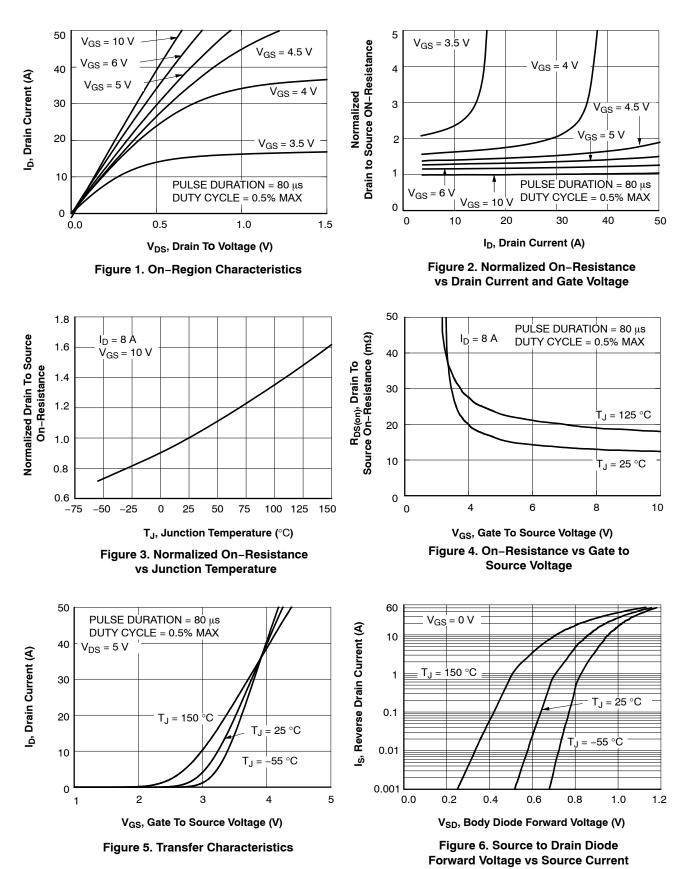
a. 65° C/W when mounted on a 1 in² pad of 2 oz copper the board designed Q1 + Q3 or Q2 + Q4.



b. 135° C/W when mounted on a minimum pad of 2 oz copper the board designed Q1 + Q3 or Q2 + Q4.

TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)



TYPICAL CHARACTERISTICS (continued)

 $(T_J = 25^{\circ}C \text{ unless otherwise noted})$

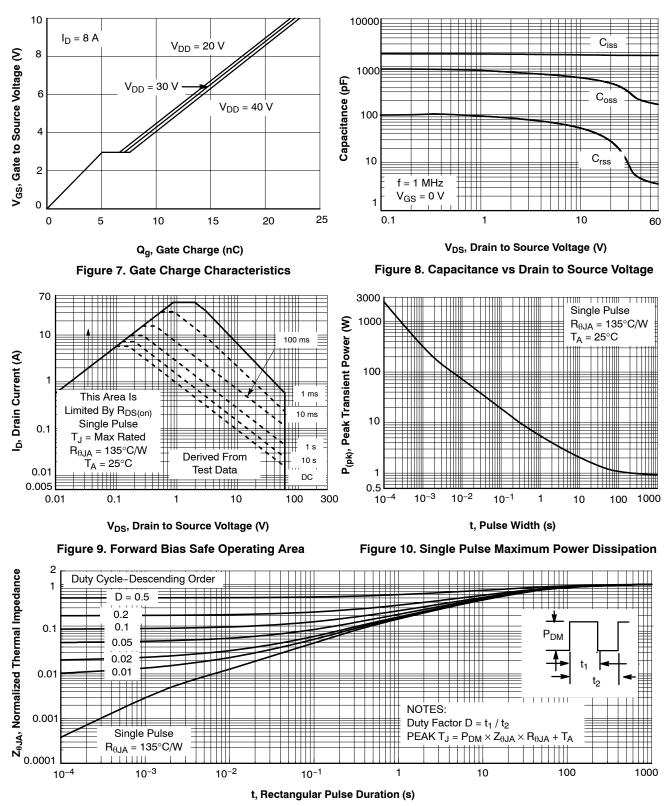


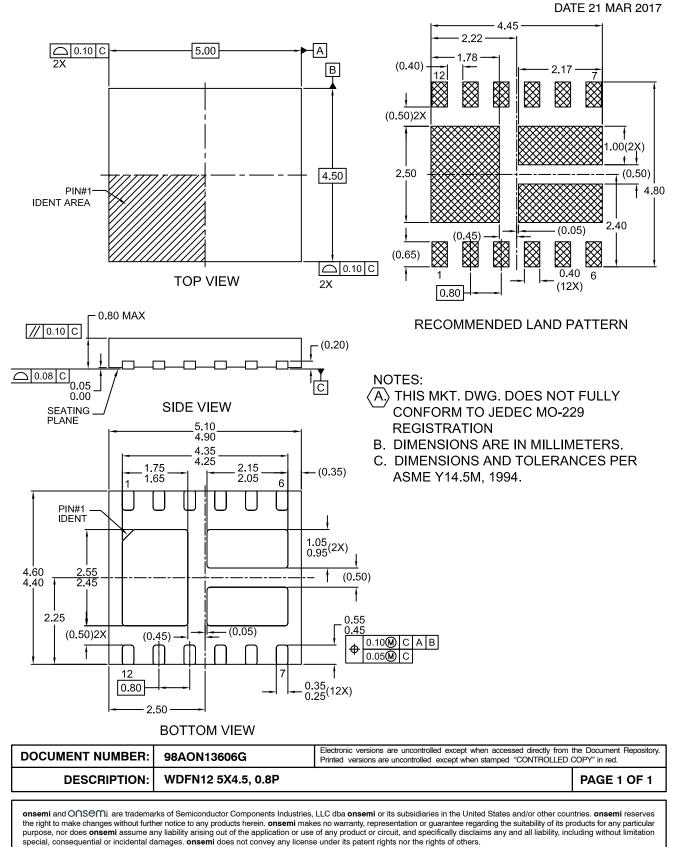
Figure 11. Junction-to-Ambient Transient Thermal Response Curve

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WDFN12 5x4.5, 0.8P CASE 511CR

ISSUE A



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